MS1088

Fully Calibrated Temperature Sensor IC

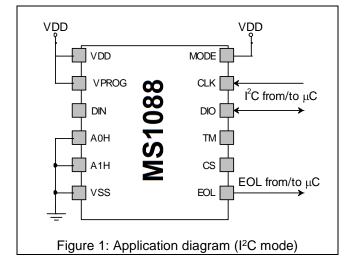
1 General Description

The integrated circuit MS1088 is a fully integrated tested and calibrated digital low power temperature sensor with a typical temperature measurement accuracy of $\pm 0.3^{\circ}$ C. It offers digital SPI or I²C interface and battery end-of-life (EOL) detection. The MS1088 is available in quad flat no leads package (QFN) or chip scale package.

2 Applications

- Wireless sensor tags
- Human body temperature measurement
- Wearables
- Power-Supply temperature monitoring
- Environmental temperature monitoring and HVAC
- Computer peripheral thermal protection
- Notebook computers
- Cell phones
- Battery management
- Thermostat controls

3 Typical application



4 Features

- Digital output: I²C serial 2-wire or SPI serial 4-wire
- Up to 4 sensors can be addressed over the same serial bus (4 sub-addresses)
- Hardware-Handshake to wake up your Microcontroller when measurement is finished.
- Temperature measuring range : -40°C to +120°C
- Accuracy: typically ±0.3°C from 10°C to +40°C
- Resolution: 0.05°C
- Ultra low current in sleep mode: 20nA
- Fast measurement time: 50 ms
- Current in active state : 75 µA
- Avg. current at 1 measurement per minute: 80 nA
- Supply range: 2.2V to 3.5V
- Battery EOL detection: threshold level programmable between 2.20V to 2.95V
- Digital output pin for EOL detection
- Available in QFN or CSP package

5 Ordering Information

	Table 1: Ordering information						
Туре	Package	Shipping	Article No.				
MS1088D	QFN16 3x3mm	Tape&Reel	9160372				
	CSP 1.39x0.93mm	Tape&Reel	9160379				

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6 Pinout

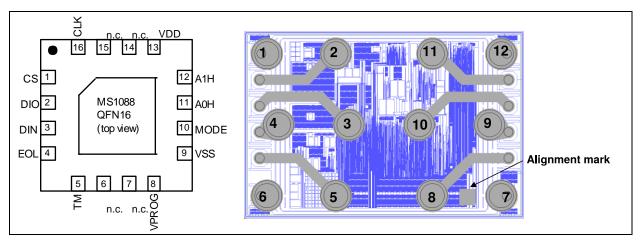


Figure 2 Pinout QFN

Figure 3 Pinout CSP

7 Pin description

Pin	Symbol	I/O ¹	Description
1	CS	1	Chip select (SPI)
2	DIO	I/O	Data input/output
3	DIN	1	Data input (SPI)
4	EOL	0	Battery EOL output
5	ТМ	I/O	Hardware Handshake
6			n.c.
7			n.c.
8	VPROG	S	Positive supply voltage
9	VSS	S	Ground
10	MODE	I	Serial interface mode
11	A0H	I	Sub-address A0H
12	A1H	I	Sub-address A1H
13	VDD	S	Positive supply voltage
14			n.c.
15			n.c.
16	CLK	1	Serial clock

8 Reset

After power up the MS1088 must be initialized dependent on the selected interface.

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¹ I: Input, O: Output, S: Supply

8.1 Initialize in I2C Mode

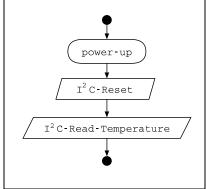


Figure 4 Initialize I²C Mode

8.2 Initialize in SPI Mode

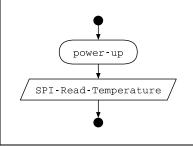


Figure 5 Initialize SPI-Mode

9 Serial interface selection

The MS1088 supports two serial interfaces: I²C or SPI. Both are implemented as slave interfaces. The selection between the two interfaces is made by the input pin MODE.

		Table	3: Serial interface selection
MODE	Serial Interface	Pin	Description
0	SPI	CLK	Serial clock (SCLK)
		DIO	MISO (master in / slave out)
		DIN	MOSI (master out / slave in)
		CS	Chip select:
			CS = '0': SPI interface is enabled
			CS = '1': SPI interface is disabled and output DIO is in high
			impedance state
1	I ² C	CLK	Serial clock (SCL; chip internal pull-up resistor connected to
			VDD)
		DIO	Serial data (SDA; chip internal pull-up resistor connected to
			VDD)
		DIN	Not used; do not connect
		CS	Not used; do not connect

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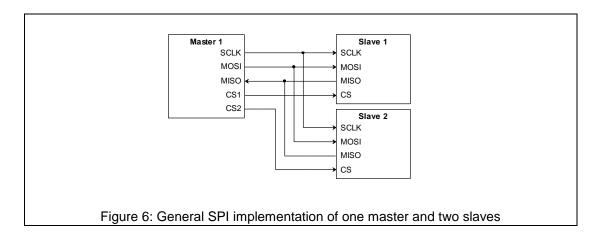
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10 Serial peripheral interface (SPI)

SPI is a synchronous serial 4-wire protocol. The signals are MOSI (master out / slave in), MISO (master in / slave out), SCLK (serial clock) and CS (chip select).

Three signals are shared between all devices on the same SPI bus: SCLK, MOSI and MISO. SCLK is generated by the master device and is used for synchronization. MOSI and MISO are the two data lines. The direction is indicated by the names. The data flows simultaneously in both directions.

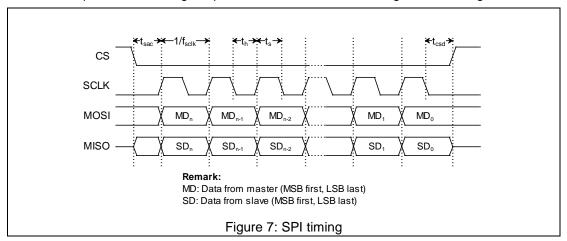
Each slave has its own CS line. The master pulls the CS line to '0' to communicate with a slave. The MS1088 is always in slave mode.

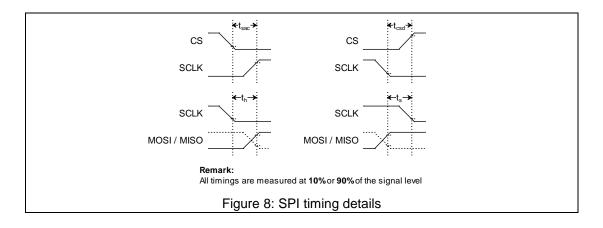


10.1 SPI protocol

The data flow of the SPI serial interface is defined by the parameters Clock Polarity (CPOL) and Clock Phase (CPHA). MS1088 expects CPOL = '0' and CPHA '1 which means that the data is clocked by the falling edge of the clock signal.

The CS signal of the addressed slave must be pulled to '0' before a data transmission can be started and must stay at '0' during the data transmission. The serial interface of the MS1088 immediately enters a reset state if the CS signal is pulled to '1'. During the reset state the output MISO is in high impedance state and the clock signal SCLK is ignored.





10.2 Addressing the MS1088 in SPI mode

The two address pins A0H and A1H are used to define the hardware address of the MS1088. This allows connection of up to four MS1088 on the same 4-wire SPI bus. A MS1088 is addressed if the value of the hardware address bits A0H and A1H is equal to the value of the address bits A0S and A1S in the SPI data protocol.

A0H	A1H	A0S	A1S	Description
'a'	ʻb'	'a'	ʻb'	MS1088 addressed
'a'	ʻb'	'a'	'a'	MS1088 not addressed
'a'	ʻb'	ʻb'	'a'	MS1088 not addressed
'a'	ʻb'	'b'	'b'	MS1088 not addressed

Table 4: Addressing the MS1088 in SPI Mode¹

¹ The logical values of 'a' and 'b' can either be '0' or '1'

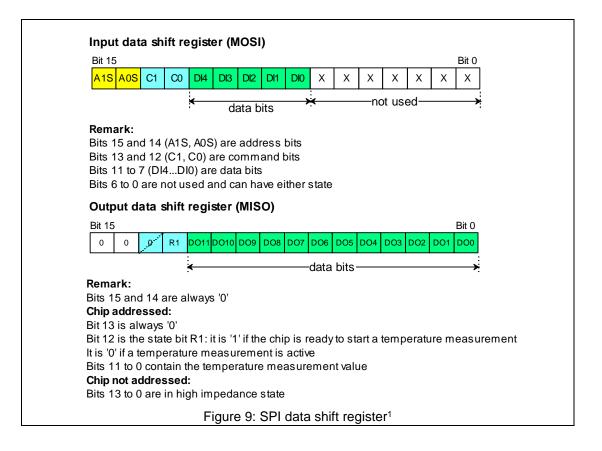
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10.3 SPI data shift register

The SPI data shift register of MS1088 has a size of 16 bits. The first two bits are the address bits A0S and A1S, the next two bits are control and state bits followed by the data bits.



¹ The chip is ready to start a temperature measurement if the state bit R1 is '1'. The chip is not ready to start a temperature measurement or a temperature measurement is already active if R1 is '0'. The command S2 is ignored in this case.

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10.4 SPI commands

Command	C1	C0	Data DI/DO	Description
			D11=MSB, D0=LSB	•
S1	0	0	TD = DO[110]	Read temperature value TD ¹
S2	0	1	-	Start temperature measurement once ²
S3	1	0	DI[40] = '0xxxx'	Deactivate EOL measurement.
			DI[40] = '10000'	Set EOL threshold level $V_{th0:EOL} = 2.20V$
			DI[40] = '10001'	Set EOL threshold level $V_{th1:EOL} = 2.25V$
			DI[40] = '10010'	Set EOL threshold level V _{th2:EOL} = 2.30V
			DI[40] = '10011'	Set EOL threshold level V _{th3:EOL} = 2.35V
			DI[40] = '10100'	Set EOL threshold level V _{th4:EOL} = 2.40V
			DI[40] = '10101'	Set EOL threshold level $V_{th5:EOL} = 2.45V$ (default)
			DI[40] = '11111'	Set EOL threshold level Vth15:EOL = 2.95V

Table 5: SPI	command	table
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10.5 Temperature conversion

The temperature T is calculated by inserting the digital temperature value TD received by command S1 into the following formula:

$$T (^{\circ}C) = \frac{TD}{20} - 80$$
$$T (^{\circ}F) = \left(\frac{TD}{20} - 80\right) \times 1.8 + 32$$

11 I²C interface

The MS1088 has a slave receiver/transmitter I²C interface. Pin CLK (SCL) is clock and pin DIO (SDA) is data input/output. DIO has an open-drain drive. Pull-up resistors are connected internally to CLK and DIO. Additional pull-up resistors need to be connected to CLK and DIO if the external load on pins CLK and DIO is too high.

11.1 Addressing the MS1088 in I²C mode

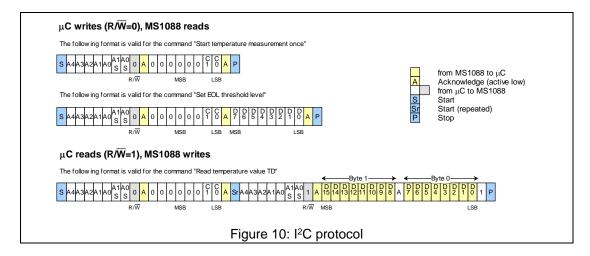
The 7 bit I²C slave address consists of five base address bits A4 to A0 and two sub-address bits A1S and A0S. The MS1088 is addressed correctly if the slave address matches with the base address and the sub-address bits match with the hardware address bits A1H and A0H. With the two sub-address bits it is possible to operate four MS1088 independently on the same I²C bus.

Table 6:I ² C slave address							
Bit A4 A3 A2 A1 A0 A1S A0S						A0S	
	1	0	0	1	0	A1S	A0S

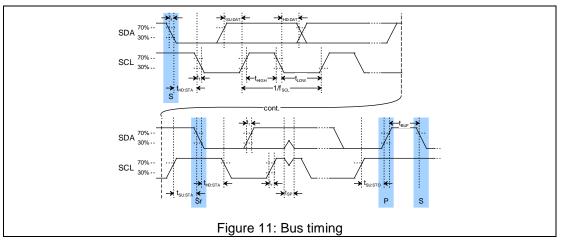
² The command S2 is ignored if a temperature measurement is active.

¹ The TD value is 0 if no temperature measurement had been performed or a temperature measurement is currently active.

11.2 I²C protocol



11.3 I²C bus timing



Noise suppression is implemented on both inputs DIO (SDA) and CLK (SCL). For further information about the I²C bus refer to the NXP "I²C-bus specification and user manual", Rev. 03, June 2007.

11.4 I²C commands

Command	C1	C0	R/W	Data D15=MSB, D0=LSB	Description
11	0	0	1	TD = D[150]	Read temperature value TD ¹
12	0	1	0	-	Start temperature measurement once ²
13	1	0	0	DI[40] = '0xxxx' DI[40] = '10000' DI[40] = '10001' DI[40] = '10010' DI[40] = '10011' DI[40] = '10100' DI[40] = '10101'	Deactivate EOL measurement. Set EOL threshold level $V_{th0:EOL} = 2.20V$ Set EOL threshold level $V_{th1:EOL} = 2.25V$ Set EOL threshold level $V_{th2:EOL} = 2.30V$ Set EOL threshold level $V_{th3:EOL} = 2.35V$ Set EOL threshold level $V_{th4:EOL} = 2.40V$ Set EOL threshold level $V_{th5:EOL} = 2.45V$ (default)
14	1	1	0	-	Chip reset

11.5 Temperature conversion

The digital temperature value TD is stored in the first 12 bits D[15]...D[4] of the data received by command I1. The Temperature can be calculated by the following formula:

T (°C) =
$$\frac{\text{TD}}{20} - 80$$

T (°F) = $\left(\frac{\text{TD}}{20} - 80\right) \times 1.8 + 32$

The other 4 bits are generated according to a simple error correcting code (ECC), which will correct a transmission error of 1 bit (and detect an error of 2 bits).

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¹The TD value is 0 if no temperature measurement had been performed or a temperature measurement is currently active.

² The command I2 is ignored if a temperature measurement is active. An active temperature measurement is indicated if the MS1088 suppresses the acknowledge signal.

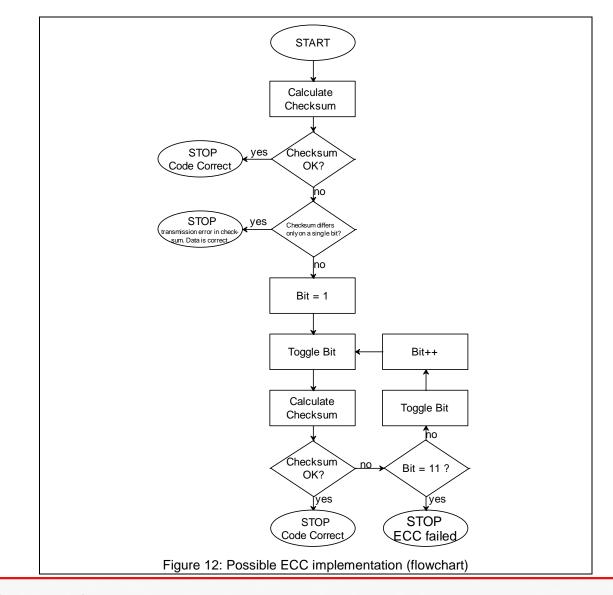
11.6 Error Correcting Code (ECC)

In I²C mode, the MS1088 encodes the last 4 bits (D3, D2, D1, D0) with an ECC, which may be used to correct transmission errors. The bits are calculated by the following formulas:

 $D3 = D15 \oplus D14 \oplus D13 \oplus D9 \oplus D8 \oplus D7 \oplus D5$ $D2 = D15 \oplus D12 \oplus D11 \oplus D9 \oplus D8 \oplus D6 \oplus D5$ $D1 = D14 \oplus D11 \oplus D10 \oplus D9 \oplus D7 \oplus D6 \oplus D5$ $D0 = D13 \oplus D12 \oplus D10 \oplus D8 \oplus D7 \oplus D6 \oplus D5$

The Symbol \oplus represents an XOR operator. If implemented by a sequential code, the bits of each formula may also be added, if the result is an even number, the ECC-bit is logical 0, otherwise it's a logical 1. Since a 1-error-correcting Code with four parity-bits can have up to 2^{11} words (see "Hamming Code"), the last bit of TD (D[4]) is not protected by the ECC. But an error on the LSB will result in an overall temperature error of just 0.05 K.

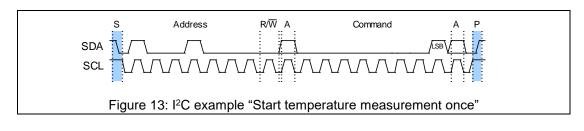
The result "ECC failed" will occur, if there are two transmission errors.

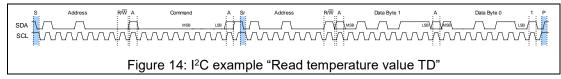


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11.7 I²C communication examples





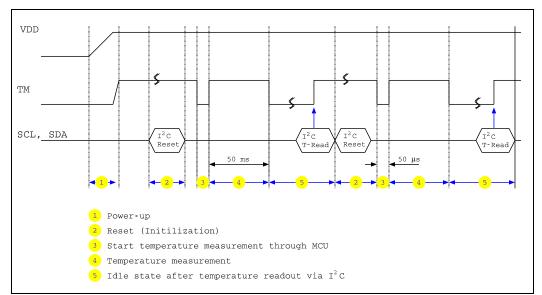
The digital value D is '0101 0111 1001 0110' (MSB to LSB) in the example above. Since the last four Bits are used for the ECC, the temperature is stored in the first 12 Bits. Therefore, the digital temperature value TD is '0101 0111 1001' (binary). This corresponds to a decimal TD value of 1401, which corresponds to an analogue temperature value TA of -9.95°C.

12 Hardware Handshake

In addition to starting a measurement using an interface command (I2 or S2), the MS1088 offers a simple hardware handshake to start a measurement and receive a "measurement finished" signal, which may be used as a wake-up interrupt.

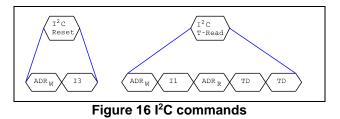
To start a measurement, the pin TM needs to be set to 0 by the micro controller for at least 50 microseconds. After the measurement is done, the Pin TM will change to 0 until the result is read out.

To receive a signal, the microcontroller has to be set to a high-impedance mode. If the function should not be used, do not connect the pin, since its state is always defined.



12.1 Hardware Handshake I2C-Mode

Figure 15 Signal waveform I²C-Mode



12.2 Hardware Handshake SPI-Mode

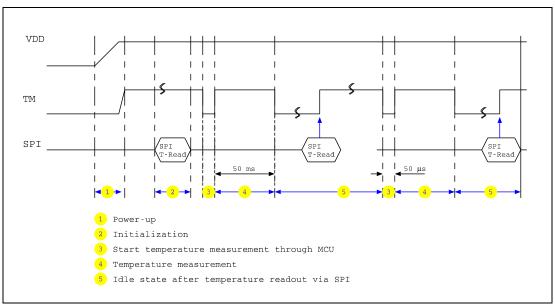


Figure 17 Signal waveform SPI-Mode

13 EOL battery detection

The supply voltage V_{DD} is compared before each temperature measurement with the EOL threshold level V_{TH:EOL}. The digital output EOL remains in the logic '0' state if V_{DD} is greater than V_{TH:EOL}. When V_{DD} falls below V_{TH:EOL} the output is driven to a logic '1' state. The output EOL is driven in sleep and in active mode.

Sixteen different threshold levels from 2.20V to 2.95V in steps of 50mV can be set by serial bus commands. If the signal is not needed, EOL battery detection can be turned off. Refer to sections 10.4 and 11.4 for details. Deactivating the EOL measurement keeps the last result. It does not reset the EOL pin to logic '0' state.

The EOL result does not affect the temperature measurement.

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14 Characteristics

14.1 Limiting values and ESD protection

Table 8: Limiting values¹ and ESD Protection²

Name	Parameter		Min	Max	Unit
Vdd	Positive supply voltage wrt to Vss		-0.5	3.5	V
VI	Input voltages wrt to Vss		-0.5	V _{DD} +0.5	V
lı, lo	Input and output currents		-10	10	mA
Ivss	Total current to Vss		-25	25	mA
Ртот	Power dissipation			300	mW
T _{stg}	Storage temperature		-60	+125	°C
TJ	Junction temperature			+125	°C
VESD (1)	Electrostatic discharge voltage	CDM		+/- 1000	V

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14.2 Sensor performance

Table 9: Sensor performance Conditions: $V_{DD} = 3.0V DC^3 T = 25^{\circ}C$ if not stated otherwise

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TError	Temperature error	$T = 10^{\circ}C$ to $+40^{\circ}C$	±0.5	±0.3	±0.5	°C
	(see Figure 13)					
T _{RES}	Resolution (LSB)			0.05		°C
T _{PSVD}	Power supply voltage			±0.1		°C/V
	dependency					
tтм	Measuring time of single			50		ms
	temperature conversion					

Important notes:

- 1. Assuming a Gaussian distribution the typical values represent 97% of the circuits.
- 2. Assuming a Gaussian distribution the max values represent about ±4 sigma (>99.99%) of the circuits.
- 3. The temperature sensor calibration data is stored in OTP (one time programmable) memory. The temperature sensor itself cannot be recalibrated. To improve the temperature sensor accuracy the whole temperature sensor application has to be calibrated at one or more temperatures. The correction curve (e.g. offset value for one point calibration) has to be stored externally (e.g. microcontroller).

³Calibration temperature

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¹ These are stress ratings only. Stress above one or more of the limiting values may cause permanent damage to the device. Operation of the device at these or at any other conditions above those given in the characteristics section of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

² Inputs and outputs are protected against electrostatic discharge during normal handling. However to be totally safe, it is advisable to undertake precautions appropriate to handling MOS devices.

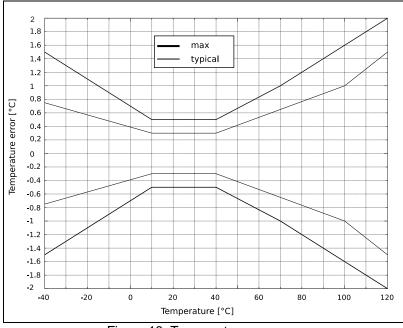


Figure 18: Temperature accuracy

14.3 DC Characteristics

Table 10: DC characteristics	
conditions: $V_{DD} = 3.0V DC$, T = 25°C, if not stated oth	erwis

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DD}	Positive supply voltage	IC operation ¹	2.2	3.0	3.6	V
		Temperature measurements	2.4	3.0	3.6	V
ldd	Operating current	Stand-by		20		nA
		Measuring temperature		75		μA
		Average (one measurement every 60 seconds)		80		nA
		V _{th0:EOL}		2.20		V
		Vth1:EOL		2.25		V
		Vth2:EOL		2.30		V
		Vth3:EOL		2.35		V
		Vth4:EOL		2.40		V
		Vth5:EOL (default value)		2.45		V
		Vth6:EOL		2.50		V
Vth:EOL	EOL threshold level	V _{th7:EOL}		2.55		V
V th:EOL		Vth8:EOL		2.60		V
		Vth9:EOL		2.65		V
		Vth10:EOL		2.70		V
		Vth11:EOL		2.75		V
		Vth12:EOL		2.80		V
		V _{th13:EOL}		2.85		V
		Vth14:EOL		2.90		V
		Vth15:EOL		2.95		V
VEOL	EOL output level	EOL = '1'; I _{EOL} = -1mA	0.8 V _{DD}			V
VEOL		$EOL = '0'; I_{EOL} = 1mA$			$0.2 V_{DD}$	V
Vdio:spi	DIO output level in SPI	MODE = '0', DIO = '1', I _{DIO} = -1mA	0.8 V _{DD}			V
V DIO:SPI	mode	MODE = '0', DIO = '0',			0.2 V _{DD}	V

¹ All commands can be executed, but temperature accuracy may not be sufficient

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		I _{DIO} = 1mA				
VIH	Input high level for digital inputs		0.7 V _{DD}		Vdd	V
VIL	Input low level for digital inputs		V _{SS}		0.3 V _{DD}	V
R _{SCL}	Internal pull-up resistor on SCL	MODE = '1'		145		kΩ
Rsda	Internal pull-up resistor on SDA	MODE = '1'		145		kΩ
T _{amb}	Operating temperature range		-40	25	120	°C
Cload	Load capacitance at pin TM	No external pull-up resistor			10	pF

14.4 AC Characteristics

Table 11: AC characteristics¹ Conditions: $V_{DD} = 3.0V$ DC, T = 25°C, if not stated otherwise

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{sclk}	SPI clock frequency	SPI mode; MODE = '0' Load at DIO: C < 20pF, R > 1M Ω			1.0	MHz
t _{SAC}	Waiting time between falling edge of CS and first rising edge of clock	SPI mode; MODE = '0'	500			ns
tcsp	Waiting time between last falling edge of clock and rising edge of CS	SPI mode; MODE = '0'	500			ns
t _h	Data hold time	SPI mode; MODE = '0'	100			ns
ts	Data setup time	SPI mode; MODE = '0'	100			ns
fscl	I ² C clock frequency	I ² C mode; MODE = '1'			100	kHz
t hd:sta	Hold time (repeated) START condition	I ² C mode; MODE = '1'	4.0			μs
tsu:sta	Set-up time (repeated) START condition	I ² C mode; MODE = '1'	4.7			μs
t _{LOW}	LOW period of the SCL clock	I ² C mode; MODE = '1'	4.7			μs
tніgн	HIGH period of the SCL clock	I ² C mode; MODE = '1'	4.0			μs
t hd:dat	Data hold time	I ² C mode; MODE = '1'	50			ns
tsu:dat	Data set-up time	I ² C mode; MODE = '1'	250			ns
tr	Rise time of the SDA and SCL signals	I ² C mode; MODE = '1'			1	μs
t _f	Fall time of the SDA and SCL signals	I ² C mode; MODE = '1'			0.3	μs
tsu:sto	Set-up time for STOP condition	I ² C mode; MODE = '1'	4.0			μs
t BUF	Wating time between STOP and START condition	I ² C mode; MODE = '1'	4.7			μs
t _{SP}	Spike suppression	I ² C mode; MODE = '1'			100	ns
t _{Start}	Length of start pulse at pin TM		50			μs

¹ SPI timings are measured between 10% and 90% of the signal levels, I²C timings between 30% and 70% of the signal levels.

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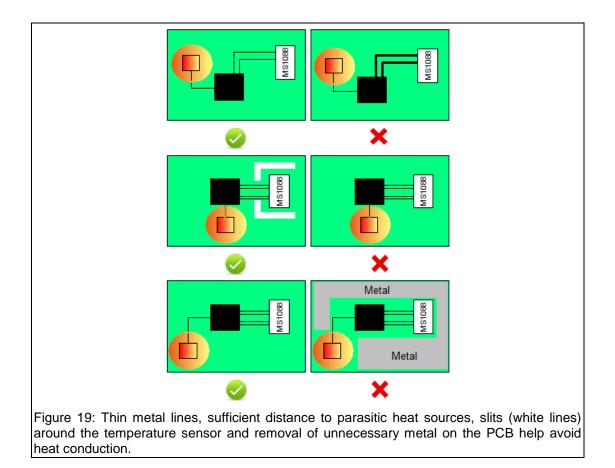
15 Application information

The MS1088 is a digital temperature sensor that is optimal for thermal management and thermal protection applications. The MS1088 is two-wire I^2C and four-wire SPI interface compatible and is specified over a temperature range of -40°C to +120°C.

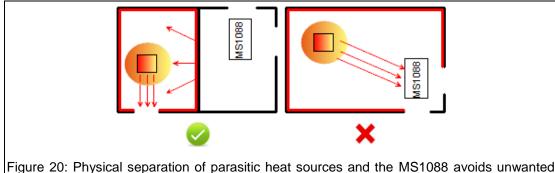
Pull-up resistors are internally connected to CLK (SCL) and DIO (SDA) in I²C mode. Additional pull-up resistors can be externally connected to CLK and DIO for high external capacitive loads. The interface's inputs and outputs are CMOS compatible in SPI mode.

15.1 Heat sources

The temperature sensor in the MS1088 is the chip itself. To maintain accuracy in applications requiring air or surface temperature measurement, care should be taken to isolate the package from ambient air temperature or parasitic heat sources. Figure 19 and Figure 20 show some basic rules how unwanted heat conduction and heat convection / heat radiation between a parasitic heat source and the MS1088 can be avoided.



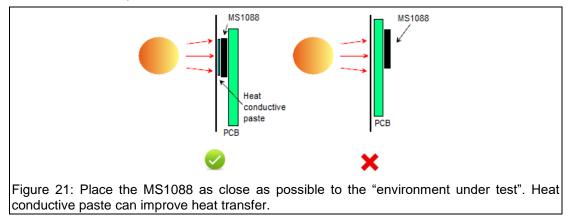
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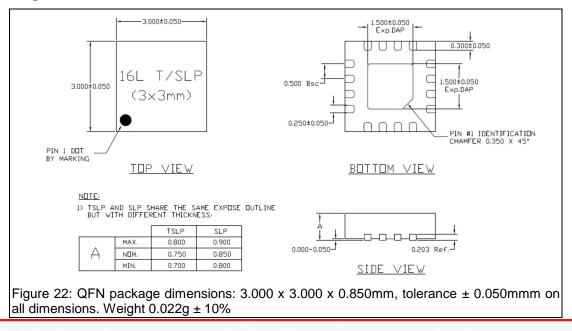
heating of the MS1088 by heat convection or heat radiation. Heating of the complete housing is avoided by sufficient heat transfer out of the housing (opening in the housing). Separation of the openings for the MS1088 and the heat transfer out of the housing avoids indirect heating.

15.2 Thermal coupling

To achieve a good thermal coupling between the MS1088 and the "environment under test" the MS1088 should be placed as close to the "environment under test" as possible. Heat conductive paste can improve the heat conduction transfer to the MS1088 and increase the accuracy of surface temperature measurements. For measuring the ambient temperature the MS1088 should be placed in an ambient airstream.



16 QFN Package Outline



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17 Application information

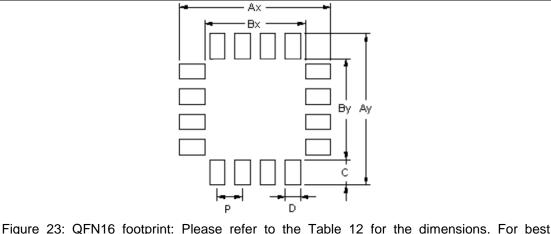


Figure 23: QFN16 footprint: Please refer to the Table 12 for the dimensions. For best temperature accuracy it is not recommended to solder the thermal pad of the QFN package to the printed circuit board

Symbol	Value	Tolerance	Unit
Р	0.5	±0.03	mm
Ax	3.8	±0.03	mm
Ay	3.8	±0.03	mm
Bx	2.1	±0.03	mm
Ву	2.1	±0.03	mm
С	0.85	±0.03	mm
D	0.3	±0.03	mm

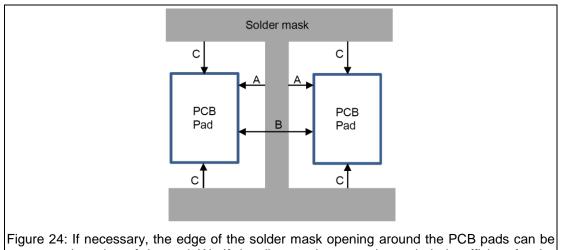


Figure 24: If necessary, the edge of the solder mask opening around the PCB pads can be set up to the edge of the pad (A). If the distance between the pads is insufficient for the solder mask (B) then the mask can be set to the bottom and the top edges of the pads (C).

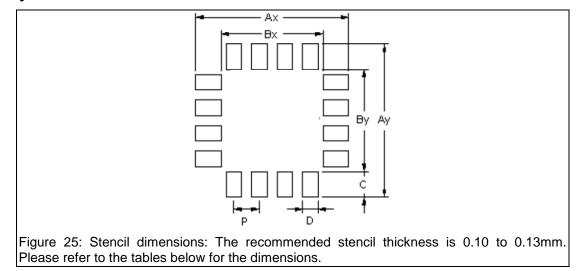
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18 Assembly instructions



Symbol	Value	Tolerance	Unit
Р	0.5	±0.03	mm
Ax	3.64	±0.03	mm
Ау	3.64	±0.03	mm
Bx	2.28	±0.03	mm
Ву	2.28	±0.03	mm
С	0.68	±0.03	mm
D	0.24	±0.03	mm

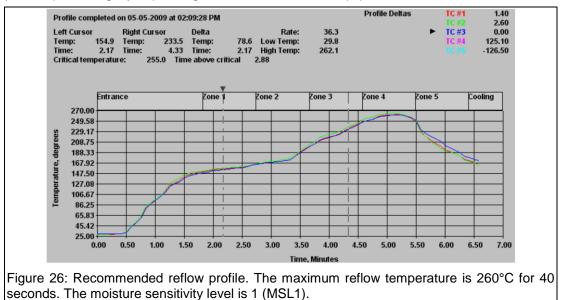
Table 13: Stencil dimensions

The recommendations in the table above are based on a stencil thickness of 0.10 to 0.13mm and the PCB footprint size given in section 16. The stencil dimensions are 80% of the footprint size. Both the stencil thickness and dimensions are recommendations. The stencil thickness and dimensions may have to be adjusted to take into account other components on the board. For example, components with leads may typically require a little more solder to compensate for co-planarity problems. Generally speaking increasing the stencil thickness and/or dimensions result in more solder being deposited and increases the risk of bridging. Decreasing the stencil thickness and/or a good solder joint.

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19 Recommended reflow parameters

The reflow profile is dependent on many different parameters. The profile here is given as a guide. It may be necessary to adjust the profile slightly depending on the solder flux and equipment used.



20 Legal disclaimer

This product is not designed for use in life support appliances or systems where malfunction of these parts can reasonably be expected to result in personal injury. Customer using or selling this product for use in such appliances does so at his own risk and agrees to defend, indemnify and hold harmless Microdul AG from all claims, expenses, liabilities, and/or damages resulting from such use of the product.